PCB

Board size: 75.0x50.0 mm (2.95x1.97 inches)

• This is the size of the rectangle that contains the board

• Thickness: 1.6 mm (63 mils)

Material: FR4Finish: NoneLayers: 4

• Color: Green

Silk screen: TOP / BOTTOM

• Color: White

Stackup:

Name	Туре	Color	Thickness	Material	Epsilon_r	Loss tangent
F.SilkS	Top Silk Screen					
F.Paste	Top Solder Paste					
F.Mask	Top Solder Mask		10			
F.Cu	copper		35			
dielectric 1	core		480	FR4	4.5	0.020
In1.Cu	copper		35			
dielectric 2	prepreg		480	FR4	4.5	0.020
In2.Cu	copper		35			
dielectric 3	core		480	FR4	4.5	0.020
B.Cu	copper		35			
B.Mask	Bottom Solder Mask		10			
B.Paste	Bottom Solder Paste					
B.SilkS	Bottom Silk Screen					

Important sizes

Clearance: 0.2 mm (8 mils)

Track width: 0.25 mm (10 mils)

• By design rules: 0.2 mm (8 mils)

Drill: 0.5 mm (20 mils)

• Vias: 0.5 mm (20 mils) [Design: 0.3 mm (12 mils)]

• Pads: 0.9 mm (35 mils)

• The above values are real drill sizes, they add 0.1 mm (4 mils) to plated holes (PTH)

Via: 0.8/0.4 mm (31/16 mils)

- By design rules: 0.2/0.2 mm (8/8 mils)
- Micro via: yes [0.2/0.1 mm (8/4 mils)]
- Buried/blind via: yes
- Total: 9 (thru: 9 buried/blind: 0 micro: 0)

Outer Annular Ring: 0.15 mm (6 mils)

• By design rules: 0.15 mm (6 mils)

Eurocircuits class: 4B - Using min drill $0.5~\mathrm{mm}$ for an OAR of $0.15~\mathrm{mm}$

General stats

Components count: (SMD/THT)

- Top: 26/4 (SMD + THT)
- Bottom: 0/0 (NONE)

Defined tracks:

Used tracks:

- 0.25 mm (10 mils) (80) defined: no
- 0.4 mm (16 mils) (36) defined: no

Defined vias:

Used vias:

• 0.8/0.4 mm (31/16 mils) (Count: 9, Aspect: 2.0 A) defined: no

Holes (excluding vias):

- 0.8 mm (31 mils) (38)
- 0.89 mm (35 mils) (12)
- 1.0 mm (39 mils) (4)
- 3.2 mm (126 mils) (4)
- 3.45 mm (136 mils) (4)

Oval holes:

Drill tools (including vias and computing adjusts and rounding):

- 0.5 mm (20 mils) (9)
- 0.9 mm (35 mils) (38)
- 1.0 mm (39 mils) (12)
- 1.1 mm (43 mils) (4)
- 3.3 mm (130 mils) (4)

• 3.45 mm (136 mils) (4)